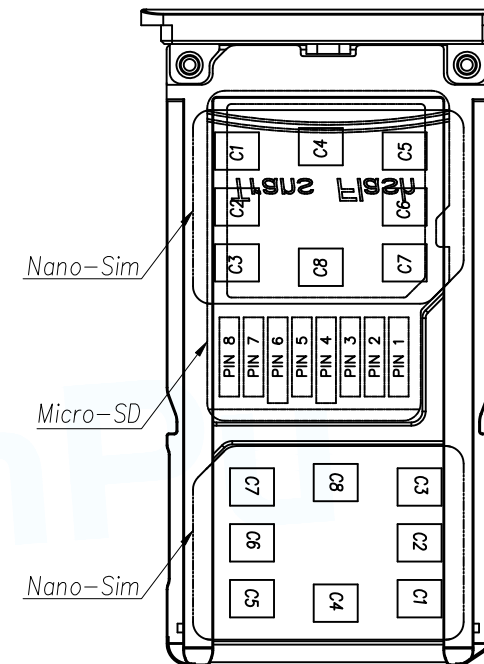
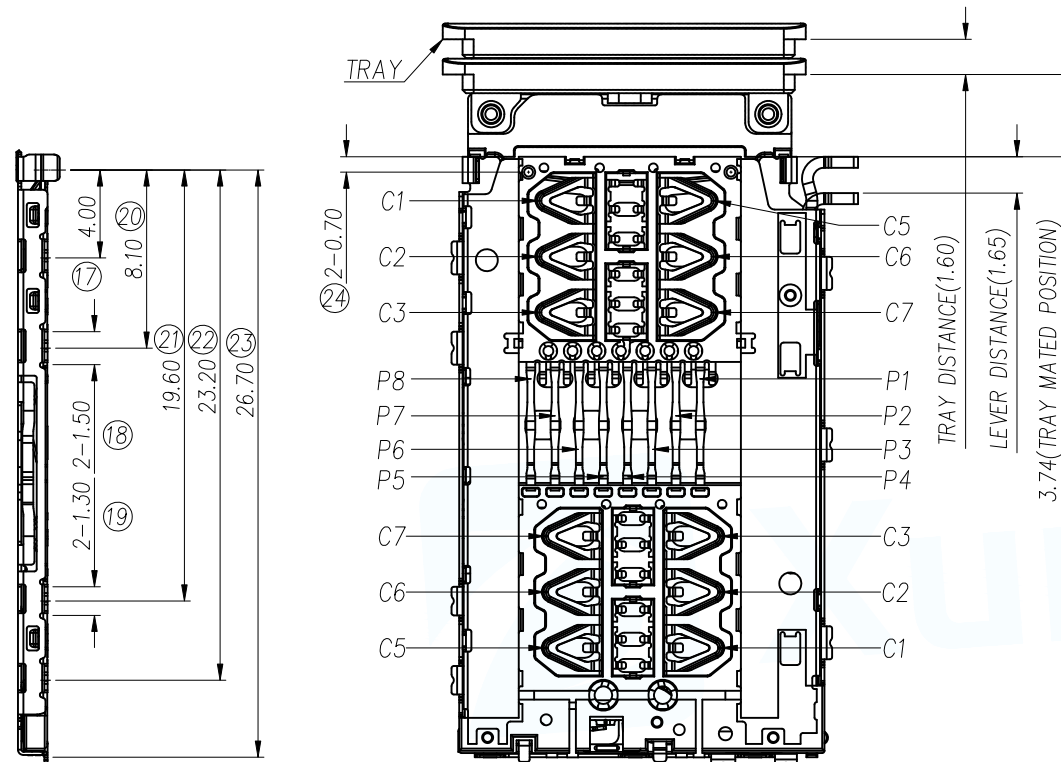


6	Eject Bar	1	SUS301-H, T=0.50±0.01mm	NA
5	Eject Lever	1	SUS301-H, T=0.50±0.01mm	NA
4	Detect Pin	1	C5240HQ-SH T=0.15±0.01mm	3u" Min Au plating on contact area 1u" Min Au plating on Solder Tails 50~120u" Ni underplating over all 80~150u" Ni plating on contact area
3	Contact	1	C5240HQ-ESH T=0.10±0.01mm	3u" Min Au plating on contact area 1u" Min Au plating on Solder Tails 50~120u" Ni underplating over all 80~150u" Ni plating on contact area
2	Shell	1	SUS301-H, T=0.15±0.01mm	1u" Min Au plating on Solder Tails 50~120u" Ni underplating over all
1	Housing	1	LCP-S475,UL94 V-0	raw material
ITEM	NAME	Q'TY	MATERIAL	PLATING

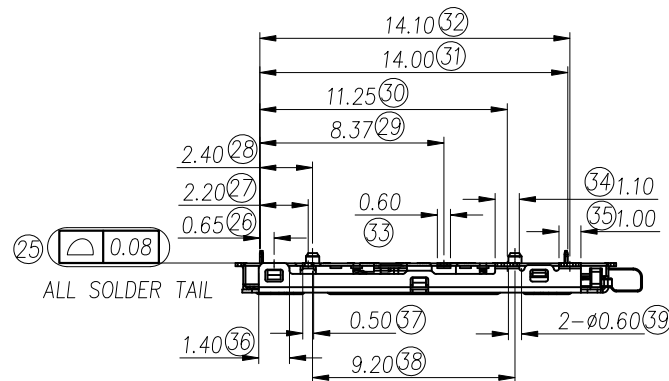
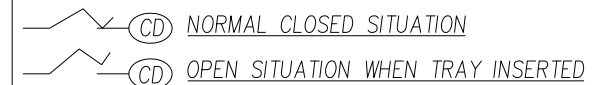
MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:1.35H 3in2 CONN NANO SIM+Micro SD/NANO SIM		
			PAR	MCS-306	
DWN	Lucas				
CHKD	Ethan				
APVD	Jacob				
DECIMALS:	ANGLES:	SCALE1:1	UNIT:MM		
.X:±0.15	X.*:±5°	CUSTOMER COPY	SIZE:A4	SHEET:1F4	REV:A
.XX:±0.10	X.X*:±3°				
.XXX:±0.05	X.XX*:±1°				



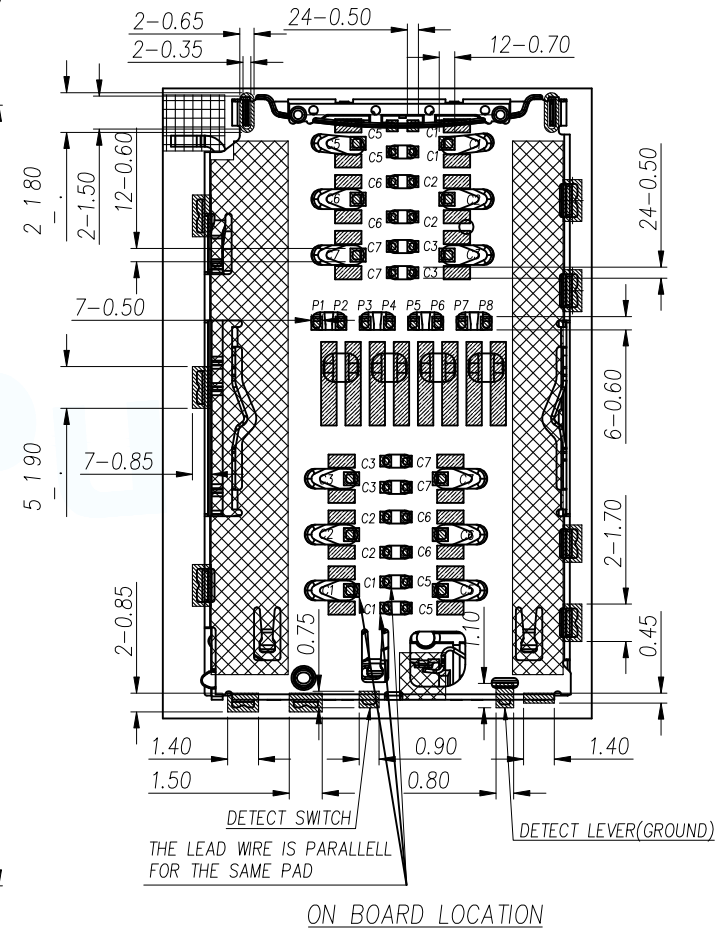
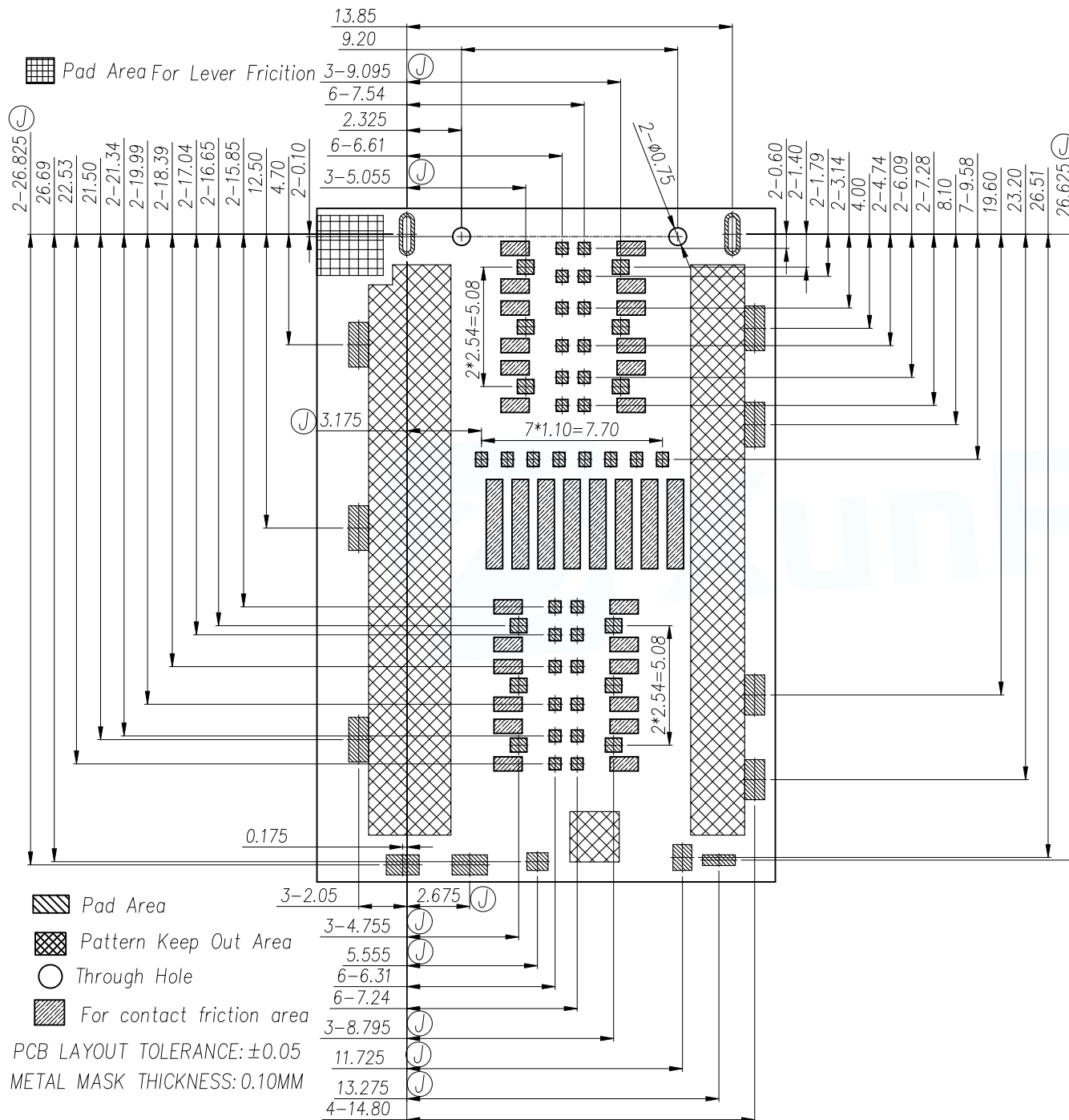
NANO SIM CARD:
PIN ASSIGNMENT
C1: Vcc
C2: RST
C3: CLK
C4: RESERVED
C5: GND
C6: VPP
C7: I/O
C8: RESERVED

MICRO SD CARD:
PIN ASSIGNMENT
P1: DAT 2
P2: CT/DAT 3
P3: CMD
P4: VDD
P5: CLK
P6: VSS
P7: DAT 0
P8: DAT 1

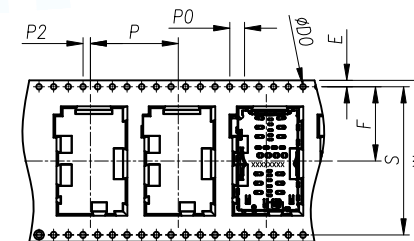
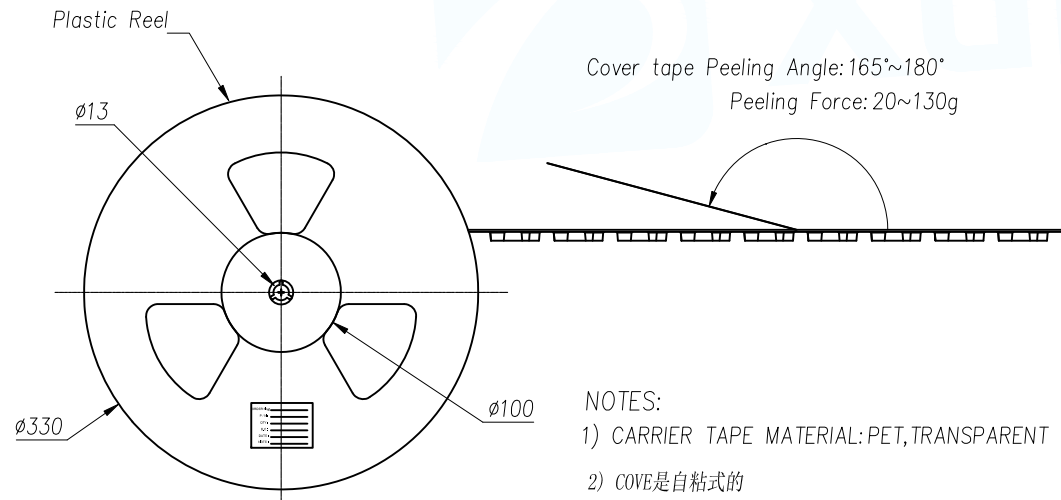
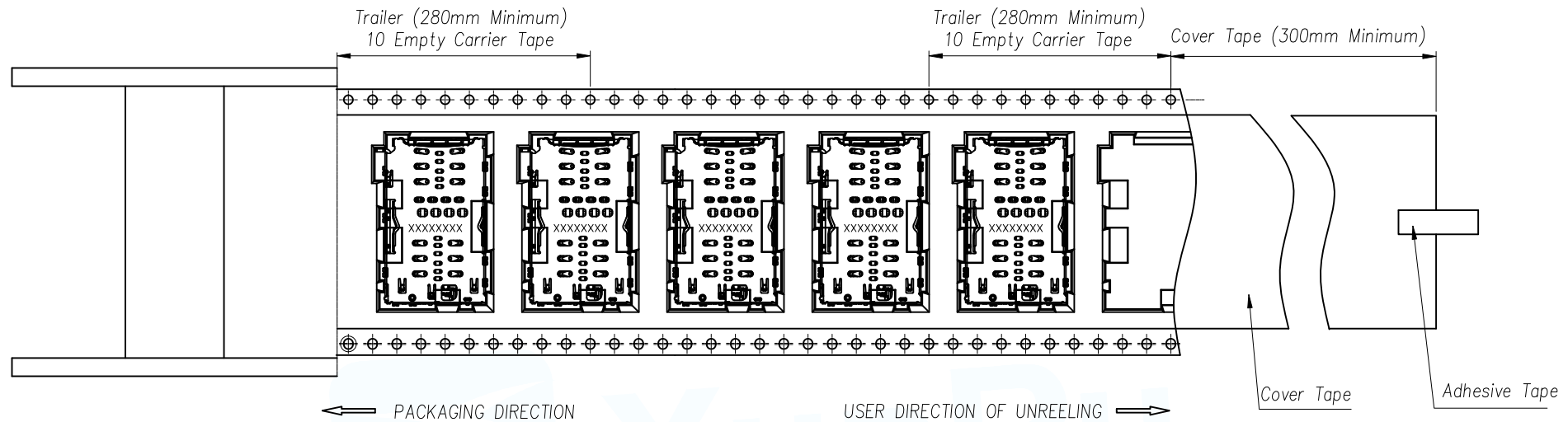
TIMING SEQUENCE



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd			
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:1.35H 3in2 CONN NANO SIM+Micro SD/NANO SIM		
			PAR	MCS-306	
DECIMALS:	ANGLES:		DWN	Lucas	
.X:±0.15	X.*:±5°		CHKD	Ethan	
.XX:±0.10	X.X*:±3°		APVD	Jacob	
.XXX:±0.05	X.XX*:±1°	CUSTOMER COPY	SCALE1:1	UNIT:MM	
			SIZE:A4	SHEET:2F4	REV:A



MANUFACTURE DWG		 东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd		
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE:1.35H 3in2 CONN NANO SIM+Micro SD/NANO SIM	
			PAR	MCS-306
DECIMALS:	ANGLES:		DWN	Lucas
.X:±0.15	X.X':±5°		CHKD	Ethan
.XX:±0.10	X.X':±3°		APVD	Jacob
.XX.X:±0.05	X.X.X':±1°		SCALE1:1	UNIT:MM
CUSTOMER COPY		SIZE:A4	SHEET:3F4	REV:A



P	24.00±0.10
P0	4.00±0.10
P2	2.00±0.10
D0	1.50±0.10
E	1.75±0.10
F	20.20±0.10
S	40.40±0.10
W	44.00±0.10

NOTES:

- 1) CARRIER TAPE MATERIAL: PET, TRANSPARENT
- 2) COVE是自粘式的

1	MCS-306	800	6	9.95	4800	340X340X335
ITEM	PRODUCT NO:	QTY/REEL	REEL/CARTON	Kg/CARTON	QTY/CARTON	CARTON SIZE

MANUFACTURE DWG			东莞市讯普电子科技有限公司 DongGuan XunPu Electronics Co.,Ltd	
UNLESS OTHERWISE SPECIFIED TOLERANCES			TITLE: 1.35H 3in2 CONN NANO SIM+Micro SD/NANO SIM	
			PAR	MCS-306
			DWN	Lucas
			CHKD	Ethan
DECIMALS:		APVD		JACOB
.X:±0.15		SCALE 1:1		UNIT:MM
.XX:±0.10		SIZE:A4		SHEET:4F4
.XXX:±0.05		CUSTOMER COPY		REV:A
ANGLES:				
X.:±5°				
X.X':±3°				
X.XX':±1°				